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EIA STANDARD

8 mm THROUGH 200 mm EMBOSSED CARRIER TAPING AND 8 mm & 12 mm PUNCHED CARRIER TAPING OF SURFACE MOUNT COMPONENTS FOR AUTOMATIC HANDLING

EIA-481-D (Revision of EIA-481-C)

JULY 2008



EIA Standards Electronic Components Association

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(From Standards Proposal No. 5173 formulated under the cognizance of the Automatic Component Handling Committee).

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8 mm THROUGH 200 mm EMBOSSED CARRIER TAPING AND 8 mm & 12 mm PUNCHED CARRIER TAPING OF SURFACE MOUNT COMPONENTS FOR AUTOMATIC HANDLING

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8 mm THROUGH 200 mm EMBOSSED CARRIER TAPING AND 8 mm & 12 mm PUNCHED CARRIER TAPING OF SURFACE MOUNT COMPONENTS FOR AUTOMATIC HANDLING

(From Standards Proposal 5173, formulated under the cognizance of the EIA Automated Component Handling Committee (ACH).

1 Scope

This Standard covers requirements for taping surface mount components. Complementary standards for specialized taping requirements are included in the addendum.

2 Introduction

This Standard was formulated to provide dimensions and tolerances necessary to tape surface mount components such that they may be automatically handled.

3 Applicable Documents

Unless otherwise specified the following documents form a part of this standard to the extent specified herein:

EIA-383 "Preparation for the Delivery of Electrical and Electronic Components"

EIA-541 "Packaging Material Standards for ESD Sensitive Items"

EIA-556 "Electronic Industries Association Outer Shipping Container Bar Code Label Standard"

EIA-583 "Packaging Material Standards for Moisture Sensitive Items"

EIA-624 "Product Package Bar Code Label Standard for Non-Retail Applications"

JED95 "JEDEC Registered and Standard Outlines for Solid State and Related Products"

IPC 7351 "Generic Requirements for Surface Mount Design and Land Pattern Standard"

4 Requirements

4.1 Carrier tapes, cover tapes, reels, and taped components must meet the requirements defined in the Figures and Tables presented herein.

4.2 Procurement documents and quotation requests shall include the following information:

(a) Reference to this Standard by Title and Number.

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- (b) Taping quality requirements including maximum number of missing components.
- (c) Container and reel marking requirements (including bar code labeling if required), and reel diameter (refer to 4.12 and Figure 10).
- (d) Shipping conditions, storage conditions and storage time.
- (e) Weight of the reel containing components. NOTE: A heavy reel may not work on all feeders. Also, a reel containing components attached to a feeder may exceed regulatory or corporate weight limits for lifting by workers.
- 4.3 Several conditions exist that may cause functional problems with carrier tapes and/or tape feeding systems even though the dimensions are within the parameters specified in the tables and figures of this document:
 - (a) Based on the carrier style, tape thickness T, tape cavity depth T₂, outside pocket width B₁, the cavity pitch P₁, or the reel flange diameter A, the following conditions may cause problems with tape feeding systems and should be considered as part of the procurement documents and quotation requests as applicable:

Туре	Tape Width	Dimension	See Figure
(Punched/Embossed)	(mm)	(mm)	
Punched/Embossed	8, 12	A > 360	14
Embossed	8	$B_1 > 4.2$	6
Punched	8, 12	T > 1.1	4
Embossed	8, 12	$P_1 = 2.0$	5
Punched	12	$P_1 = 2.0$	5
Embossed	12	$T_2 > 4.5$	6
Embossed	16, 24	$T_2 > 6.5$	6
Embossed	32 to 200	T ₂ >10.1	7
Embossed	72 to 200	P ₁ > 56	7

- (b) For 8, 12, 16 and 24 mm wide embossed tapes, if $S_1 < 1.0$ mm (Table 2 and Figure 6), there may not be enough area to obtain a proper seal between the carrier and cover tapes according to paragraphs 4.5 and 4.11 and must be considered as part of the procurement documents and quotation requests as applicable.
- (c) Users may experience problems feeding low mass components due to electrostatic effects (attraction and/or repulsion) associated with the separation of the cover taxpe and carrier tape during the feeding operation. The result of this phenomenon could cause devices to migrate, or be propelled away from the user pick up point, resulting in a mis-pick or non-pick situation during placement. To minimize this phenomenon, it is recommended that the packaging materials, component placement equipment, and controlled environmental conditions be optimized to effectively dissipate any charge buildup. This charge, commonly referred to as tribo-electric charge, should be controlled per the guidelines in EIA-541.

- (d) Carrier tapes may experience feeding problems when passed through tracks with lengths in excess of 250 mm. Figure 12 outlines the suggested measurement of camber.
- (e) Camber in excess of 1 mm over 250 mm may be generated when empty carrier tape is supplied on level-wound reels.

4.4 Components are to be prevented from falling out of the cavity of the carrier tape, and shall remain in position for automatic handling after removal of the top cover tape (see Note 1, Tables 1, 2 &3).

4.5 The cover tape(s) may not extend over the edge of the carrier tape or cover any part of the sprocket holes.

4.6 Tape in adjacent layers shall not stick together when wound on the carrier reel.

4.7 The packaging, materials and processes shall not adversely affect the mechanical and electrical characteristics or marking of the components. For intermediate and final packaging, refer to EIA-383 "Preparation for the Delivery of Electrical and Electronic Components," EIA-541 "Packaging Material Standards for ESD Sensitive Items," and EIA-583 "Packaging Material Standards for Moisture Sensitive Items," and EIA-624 "Product Package Bar Code Label Standard for Non-Retail Applications."

4.8 The tapes shall be suitable to withstand storage of the taped components without danger of migration of contaminants onto the terminations, or the emission of vapors which would make soldering difficult or deteriorate the component properties or terminations by chemical action. In addition, the cover tape(s) shall not become detached, such that the components do not remain in position after storage. The punched carrier material shall not age and lose strength such that it breaks or delaminates on unreeling when the taped components are fed from the package by hand or into the assembly machines (refer to 4.2(d)).

4.9 Components may be removed from the cavity by incising the bottom cover tape (see Figure 10) for punched carrier tape, or in the case of embossed carrier, by incising at or below the cavity depth midpoint ($K_0/2$). In no case shall the incising affect the package functionality.

4.10 There shall not be consecutive components missing from any reel for any reason.

4.11 The cover tape for each style and material of carrier tape shall have a total peel strength of from 0.1 N to 1.0 N (10 grams to 100 grams calibrated scale reading) for 8 mm carrier tapes and from 0.1 N to 1.3 N (10 grams to 130 grams calibrated scale reading) for 12 mm to 56 mm wide carrier tapes and from 0.1 N to 1.5 N (10 grams to 150 grams calibrated scale reading) for 72 mm and wider carrier tapes. Peel is defined as the separation of the full width of the cover tape from the carrier tape or the removal of the center portion of the cover tape from the carrier tape to enable component removal from the cavity. The direction of pull shall be opposite the direction of carrier tape travel such that the cover tape makes an angle of between 165 and 180 degrees with the top of the carrier tape. The cover tape, shall be pulled with a velocity of 300

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mm +/- 10 mm/minute, relative to the carrier tape, during peeling, which results in the cover/carrier tape seal being separated at a rate of 150 mm/minute.

4.12 Bar code labeling (if required) shall be on the side of the reel opposite the round sprocket holes (refer to 4.2(c) and Figure 10). Refer to EIA-556 and EIA-624.

4.13 Reels as defined by Figure 14 shall be permanently marked with visible recycling symbology.

- 4.14 The following orientation rules shall be considered as standard for multi-connection components.
 - (a) Traditionally packaged components with leaded, bottom-only terminations (e.g. PLCC, SOIC, SOJ, and BGA) shall be packaged with the terminations facing the bottom of the carrier cavity. The following rules apply whether the terminations are facing downward or upward in the cavity.
 - (b) Termination is the electrical or mechanical connection from the component to the board and can be described as lead, pin, bump, ball, wirepad, connector, etc.
 - (c) Orienting feature is the attribute on the component that identifies a unique orientation. The most accurate description should be Termination 1 (refer to IPC 7351); however in absence of Termination 1 definition, the following features can be used: fiducial mark, chamfered edge, dimple, notch, wider termination, etc. If the orienting feature is located in the exact center of the component, or it lies on the shorter axis of the component, then an alternate orienting feature on the component should be chosen.
 - (d) A component is considered square if the bounding rectangle around the outer extents of the component (including body and terminations) contains edges with a difference no greater than 0.3mm between the nominal length and width.
 - (e) The tape pocket quadrant designations that describe the taped orientation of components are shown in Figure 1.
 - (f) For existing Component Packages use Figure 2 "Orientation Guide for Commonly Used Devices".
 - (g) If a package type is not contained in Figure 2, use the rules in the sequence shown in the following flow chart (Figure 3) to determine the correct orientation of the component in the tape pocket.

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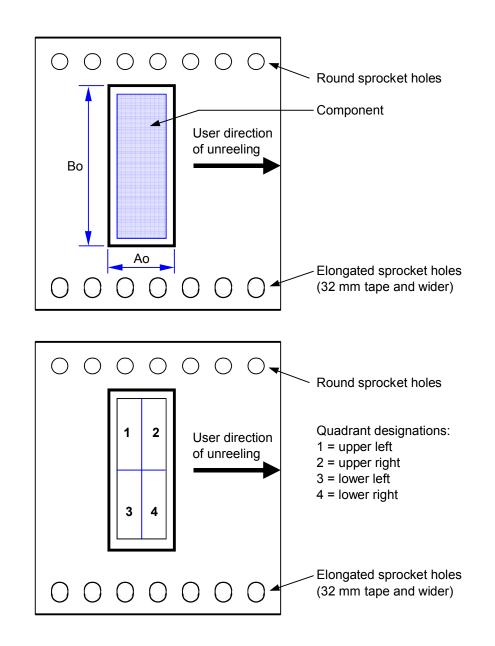


Figure 1 -- Component orientation and quadrant designations

	DIRECTION OF UNREELING									
Component Package	SOT23	SOT223	SOT143	SOT89	SOT343					
Orientation in carrier										
Termination 1 Orientation by Quadrant	1 2 3 4	1 2 3 4	1 2 3 4	1 2 3 4	1 2 3 4					
Component Package	SOT23-5 / SC70-5 / SSOP-5	SOT23-6 / SC70-6 / SSOT-6	ТО-89	DPAK / D2PAK / TO-252 / TO-220	D2PAK-5P / TO-263-5					
Orientation in carrier										
Termination 1 Orientation by Quadrant	1 2 3 4	1 2 3 4	1 2 3 4	1 2 3 4	1 2 3 4					
Component Package	QFP	TSOP	PLCC	SOIC	DIP					
Orientation in carrier					O O O O O O O O O O O O O O O O O O O					
Termination 1 Orientation by Quadrant	1 2 3 4	1 2 3 4	1 2 3 4	1 2 3 4	1 2 3 4					
Component Package	QFN (Square geometry)	QFN (Rectangular geometry)	BGA (Square geometry)	BGA (Rectangular geometry)	LCC					
Orientation in carrier										
Termination 1 Orientation by Quadrant	1 2 3 4	1 2 3 4	1 2 3 4	1 2 3 4	1 2 3 4					
Component Package	SSOP / TSSOP / MSOP	Ultra Thin SO8 (US8)	Tantalum Capacitor	DIODE / LED	Connectors (square or rectangular)					
Orientation in carrier										
Termination 1 Orientation by Quadrant	1 2 3 4	1 2 3 4	1 2 3 4	1 2 3 4	1 2 3 4					

Figure 2 – Orientation Guide for Commonly Used Devices

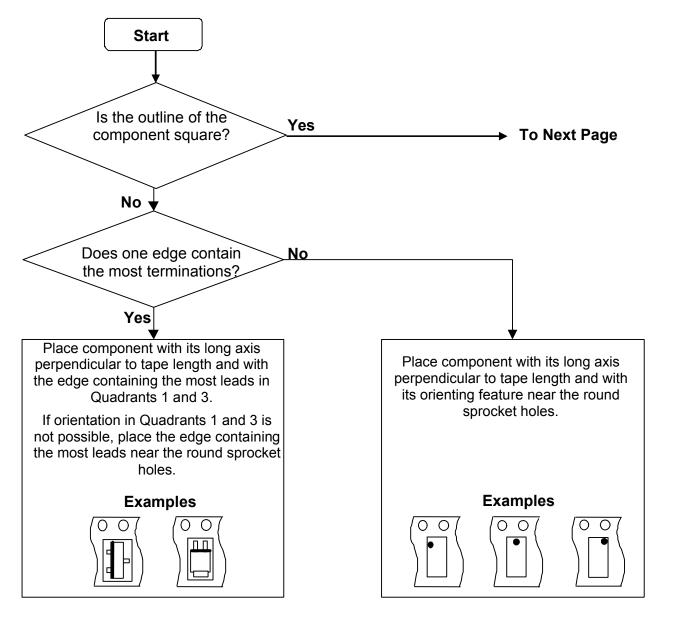


Figure 3 -- Rules for determining orientation of component in tape pocket (1 of 2)

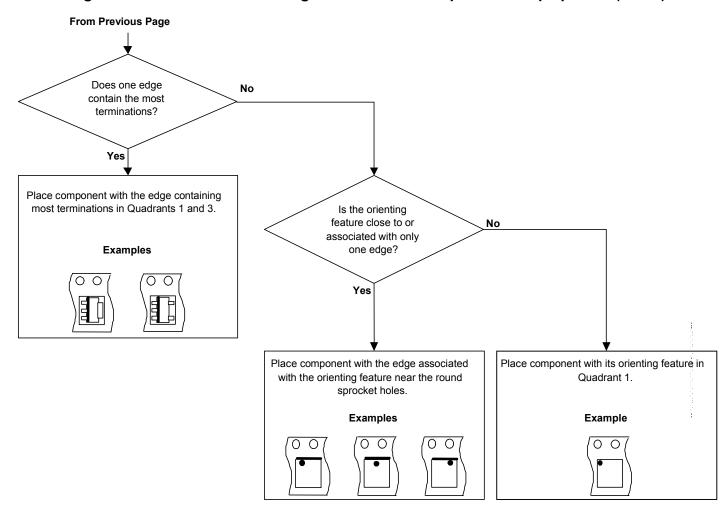
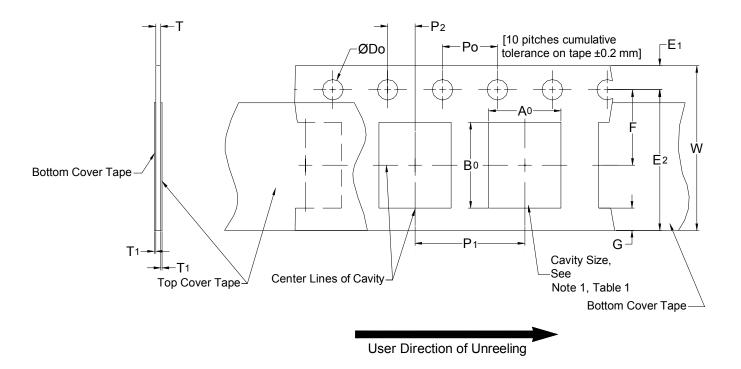


Figure 3 -- Rules for determining orientation of component in tape pocket (2 of 2)





See Section 4.0 for requirements (all dimensions in millimeters)

Figure 5 -- Illustration of 2 mm cavity pitch for 8 mm & 12 mm punched and embossed carrier, P1.

See Tables 1 & 2 and requirement 4.3

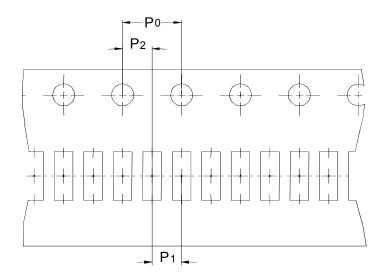


Table 1 -- 8 & 12 mm punched carrier dimensions (all dimensions in millimeters)

	Constant Dimensions										
Tape Size	D ₀	E1	P ₀	P ₂	T₁ Max.	G Min.	R Ref. See Note 2				
8 mm & 12 mm	1.5 +0.1 -0.0	1.75± 0.1	4.0 ±0.1	2.0±0.05	0.1	0.75	25				

Constant Dimensions

Variable Dimensions

Tape Size	E ₂ Min.	F	P ₁	W Max.	A ₀ B ₀	Т
8 mm	6.25	3.5± 0.05	2.0±0.05 or 4.0±0.1	8.3		1.1 mm maximum for Paper Base Tape, and
12 mm	10.25	5.5± 0.05	2.0±0.05, 4.0±0.1 or 8.0±0.1	12.3	See Note 1	1.6 mm maximum for Non-Paper Base Compositions. See Note 2 and Requirement 4.3

Notes

1 The cavity defined by A_0 , B_0 and T shall surround the component with sufficient clearance that:

a) the component does not protrude beyond either surface of the carrier tape.

b) the component can be removed from the cavity in a vertical direction without

mechanical restriction, after the top cover tape has been removed.

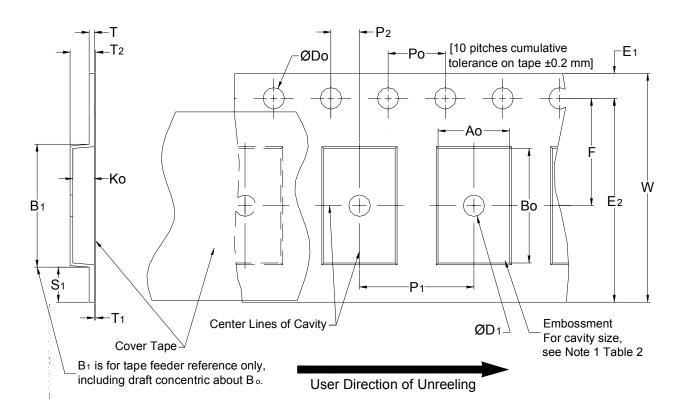
c) rotation of the component is limited to 20° maximum (see Figure 8).

d) lateral movement of the component is restricted to 0.5 mm maximum (see Figure 9).

e) see Addendum for standards relating to more precise taping requirements.

2 The tape with or without components shall pass around R without damage (see Figure 11).

Figure 6 -- 8 mm, 12 mm, 16 mm & 24 mm embossed carrier tape dimensions



See Section 4.0 for requirements (all dimensions in millimeters)

	Constant (for 2 or more widths) Dimensions											
Tape Size	D ₀	D ₁ Min.	E1	P ₀	P ₂	R Ref. See Note 2	S ₁ Min. See Note 3	T Max.	T₁ Max.			
8 mm	15401	1.0			2.0±	25						
12 mm	1.5 +0.1 -0.0		1.75	4.0	0.05		0.6	0.6	0.1			
16 mm	-0.0	1.5	±0.1	±0.1	2.0±	30	0.0	0.0	0.1			
24 mm					0.1							

Table 2 -- 8, 12, 16 & 24 mm embossed carrier dimensions

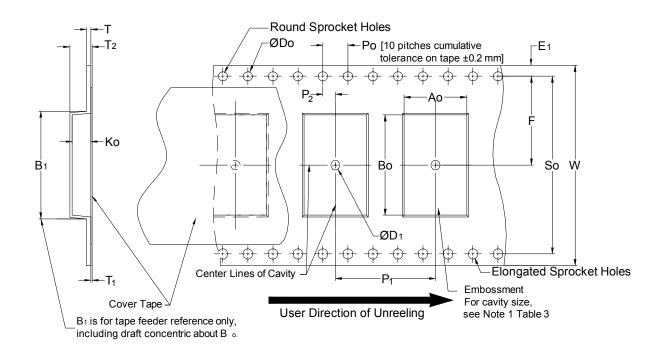
Variable Dimensions

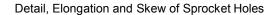
	Valiable Billionelle						
Таре	B ₁	E ₂	F	P ₁	T_2	W	A ₀ , B ₀
Size	Max.	Min.			Max.	Max	& K ₀
8 mm	4.35	6.25	3.5±	2.0±0.05 or	2.5	8.3	
0 11111	4.55	0.25	0.05	4.0±0.10	2.5	0.5	
			5.5±	2.0±0.05 or			
12 mm	8.2	10.25	0.05	4.0±0.1 or	6.5	12.3	
				8.0±0.1			Caa
			7.5	4.0±0.1 to			See Note 1
16 mm	12.1	14.25	±0.1	12.0±0.1 in	8.0	16.3	Note 1
				4.0 increments			
			11.5	4.0±0.1 to			
24 mm	20.1	22.25	±0.1	20.0±0.1 in	12.0	24.3	
				4.0 increments			

Notes

- 1 The cavity defined by A₀, B₀ and K₀ shall surround the component with sufficient clearance that:
 - (a) the component does not protrude above the top surface of the carrier tape.
 - (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - (c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm and 24 mm tapes (see Figure 8).
 - (d) lateral movement of the component is restricted to 0.5 mm maximum for 8 mm and 12 mm wide tape and to 1.0 mm maximum for 16 mm, 24 mm wide tape (see Figure 9).
 - (e) see Addendum for standards relating to more precise taping requirements.
- 2 The tape with or without components shall pass around R without damage (see Figure 11).
- 3 If $S_1 < 1.0$ mm, there may not be enough area for cover tape to be properly applied (see paragraph 4.3 (b)).

Figure 7 -- 32, 44, 56, 72, 88, 104, 120, 136, 152, 168, 184 & 200 mm embossed carrier tape dimensions





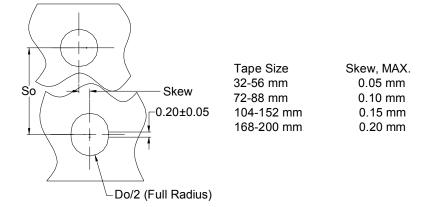


Table 3 -- 32, 44, 56, 72, 88, 104, 120, 136, 152, 168, 184 & 200 mm embossed carrier dimensions

		Constant	t Dimens	ions (fo	or 2 or mo	ore widths)		
Таре	D ₀	D ₁	E1	P ₀	P ₂	R	Т	T ₁
Size		Min.				Ref.	Max.	Max.
						See Note 2		
32 mm					2.0±0.1	50		
44 mm					2.0±0.1	50		
56 mm	1.5+0.1	2.0	1.75±	4.0±	5		0.6	0.1
72 mm through 200 mm	-0.0	2.0	0.10	0.1	2.0±0.2	75	0.0	0.1

Onetant Dimonsions	(for 2 or more widths)	
	$(101 \ge 01 11101 \in WIUU13)$	

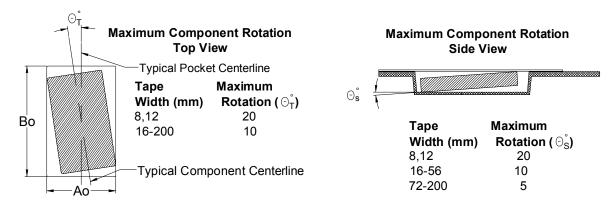
Variable Dimensions

Tape Size	B₁ Max.	F	P ₁ (in 4.0 increments)	S ₀	T ₂ Max.	W	A ₀ , B ₀ & K ₀
32 mm	23.0	14.2±0.10	4.0±0.1 to 32.0±0.1	28.4±0.1	12.0	32.0±0.3	
44 mm	35.0	20.2±0.15	4.0±0.1 to 44.0±0.1	40.4±0.1	16.0	44.0±0.3	
56 mm	46.0	26.2 ±0.15	4.0±0.1 to 56.0±0.1	52.4±0.1	20.0	56.0±0.3	
72 mm	60.0	34.2±0.30		68.4±0.1	30.0	72.0±0.3	See
88 mm	76.0	42.2±0.30		84.4±0.1	30.0	88.0±0.3	Note
104 mm	91.0	50.2±0.35		100.4±0.1	35.0	104.0±0.3	1
120 mm	107.0	58.2±0.35	1010 1 to	116.4±0.1		120.0±0.3	
136 mm	123.0	66.2±0.40	4.0±0.1 to 72.0±0.1	132.4±0.1		136.0±0.3	
152 mm	139.0	74.2±0.40	72.0±0.1	148.4±0.1	40.0	152.0±0.3	
168 mm	153.0	82.2±0.45		164.4±0.1	40.0	168.0±0.3	
184 mm	169.0	90.2±0.45		180.4±0.1		184.0±0.3	
200 mm	185.0	98.2±0.50		196.4±0.1		200.0±0.3	

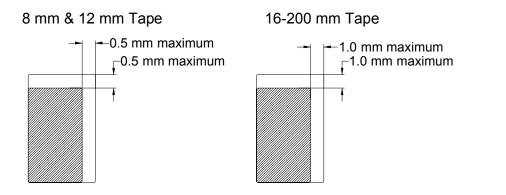
Notes

- 1 The cavity defined by A₀, B₀ and K₀ shall surround the component with sufficient clearance that:
 - (a) the component does not protrude above the top surface of the carrier tape.
 - (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - (c) rotational limits of the component in the pocket are illustrated in Figure 8.
 - (d) lateral movement of the component is restricted to 1.0 mm maximum (see Figure 9).
- The tape with or without components shall pass around R without damage (see Figure 11). 2

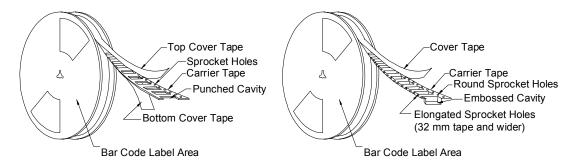
Figure 8 -- Maximum component rotation for punched and embossed carrier



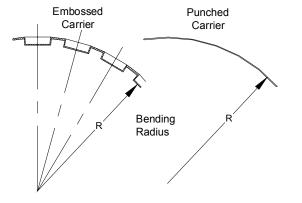












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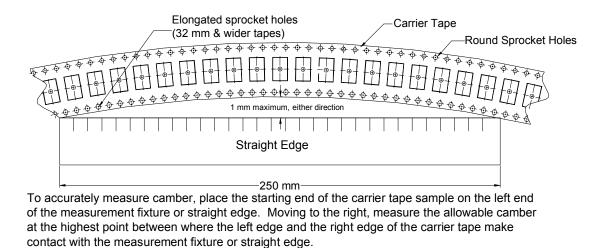
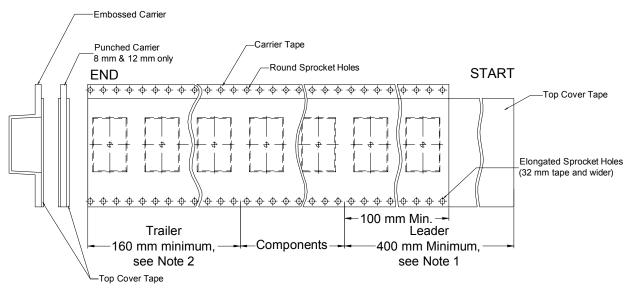


Figure 12 -- Maximum camber for punched and embossed carrier

Only measure camber in the section of carrier tape that is above the straight edge

Figure 13 -- Tape leader & trailer dimensions for punched and embossed carrier



See section 4.0 for requirements (all dimensions in millimeters)

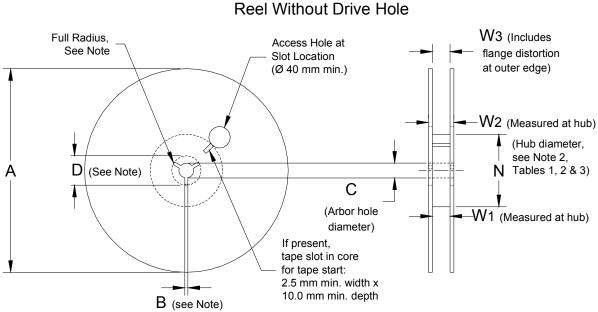
NOTES

There shall be a leader of 400 mm minimum of cover tape, which includes at least 100 mm of carrier tape with empty compartments and sealed by the cover tape. All of the leader may consist of the carrier tape with empty compartments sealed by cover tape.
 There shall be a trailer of 160 mm minimum of empty carrier tape sealed with cover tape. The entire carrier tape must release from the reel hub as the last portion of the tape unwinds from the reel without damage to the carrier tape and the remaining components in the cavities.

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Figure 14 -- Reel dimensions

See Section 4.0 for requirements (all dimensions in millimeters)



Note: Drive spokes optional; if used, dimensions B and D shall apply.

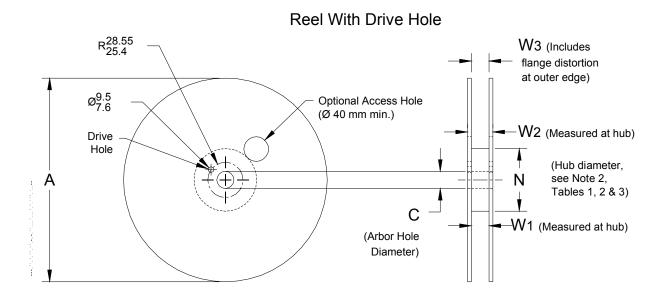


Table 4 -- Reel dimensions

See Section 4.0 for requirements (all dimensions in millimeters)

			Constant L	vimensions			
		Reels Without Drive Hole			Reels With Drive Hole		
Таре	А	В	С	D	В	С	D
Size	Max.	Min.		Min.		Max.	
8 mm to 200 mm	609	1.5	13.0+0.5 -0.2	20.2	Not Applicable	29.2	Not Applicable

Variable Dimensions

Tape Size (mm)	N Min. See Note 2, Tables 1-3	W ₁	W ₂ Max for A < 360 mm See Note 1	W ₂ Max for A ≥360 and ≤609 mm See Note 2	W ₃
8		8.4 +1.5/-0.0	14.4	14.4	
12	50	12.4 +2.0/-0.0	18.4	18.4	
16		16.4 +2.0/-0.0	22.4	29.0	
24	60	24.4 +2.0/-0.0	30.4	37.0	
32		32.4 +2.0/-0.0	38.4	45.0	
44		44.4 +2.0/-0.0	50.4	57.0	
56		56.4 +2.0/-0.0	62.4	69.0	Shall
72		72.4 Min.		89.0	Accommodate
88		88.4 Min.		105.0	Tape Width Without Interference
104	See	104.4 Min.		121.0	Without Interference
120	Note 3	120.4 Min.		137.0	
136		136.4 Min.		153.0	
152		152.4 Min.		169.0]
168		168.4 Min.		185.0	
184		184.4 Min.		201.0]
200		200.4 Min.		217.0	

Notes

1 For reels less than 360 mm diameter (A), the most widely used reel diameters are 178 mm \pm 2 mm and 330 mm \pm 2 mm. Reel diameters ranging from 254 mm to 292 mm also exist. Commonly used hub diameters are 80, 100, 150, and 178 mm.

2 For reels greater than or equal to 360 mm diameter (A), various sizes exist with the most widely used being 381 mm \pm 2 mm, 482 mm \pm 2 mm and 558 mm \pm 2 mm. Hub diameters vary widely, up to 254 mm.

3 Tape with components must wrap around hub without damage.

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James Adams – 3M Mike Balbuena – Jabil Circuit, Inc. Ted Eckerson – Jabil Circuit, Inc. Albert Escusa – Texas Instruments. Michael T. Farrell – 3M. Gonzalo Herrera – Jabil Circuit, Inc. Miguel A. Ojeda Sr. – Jabil Circuit, Inc. Doug Romm – Texas Instruments. Steven Kummerl – Texas Instruments. Henry Sipes – Samtec, Inc.

The following team members are part of the Automated Component Handling Committee:

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Addendum

Complementary Taping Standards:

- EIA-726 8 mm Punched & Embossed Carrier Taping of Surface Mount Components for Automatic Handling of Devices Smaller Than 2.0 mm x 1.2 mm
- EIA-747 Adhesive Backed Punched Plastic Carrier Taping of Singulated Bare Die and Other Surface Mount Components for Automatic Handling of Devices Generally Less Than 1.0 mm Thick
- EIA-763 Bare Die and Chip Scale Packages Taped in 8 mm & 12 mm Carrier Tape for Automatic Handling

Other Reference Documents:

ESD TR20.20	ESD Association Standard – ESD Handbook
ESD ADV 1.0	ESD Association Glossary – Glossary of Terms
SEMI E78	Semiconductor Equipment and Materials International Standard– Electrostatic Compatibility – Guide to Assess and Control Electrostatic Discharge (ESD) and Electrostatic Attraction (ESA) for Equipment

Recommendation:

For waste minimization purposes it is recommended that the industry modify its methods and equipment so that the minimum leader dimension can be eventually reduced from 400 mm to 320 mm and that the minimum trailer dimension be reduced from 160 mm to 80 mm.

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EIA Document Improvement Proposal

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